

Vishay Siliconix

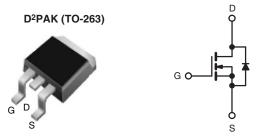
RoHS

COMPLIANT **HALOGEN**

FREE

Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	100			
$R_{DS(on)}(\Omega)$	V _{GS} = 10 V	0.16		
Q _g (Max.) (nC)	26			
Q _{gs} (nC)	5.5			
Q _{gd} (nC)	11			
Configuration	Single			



N-Channel MOSFET

FEATURES

- Halogen-free According to IEC 61249-2-21 **Definition**
- Surface Mount
- Available in Tape and Reel
- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- 175 °C Operating Temperature
- Fast Switching
- Ease of Paralleling
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The D²PAK (TO-263) is a surface mount power package capable of accommodating die size up to HEX-4. It provides the highest power capability and the lowest possible on-resistance in any existing surface mount package. The D²PAK (TO-263) is suitable for high current applications because of its low internal connection resistance and can dissipate up to 2.0 W in a typical surface mount application.

ORDERING INFORMATION				
Package	D ² PAK (TO-263)	D ² PAK (TO-263)	D ² PAK (TO-263)	
Lead (Pb)-free and Halogen-free	SiHF530S-GE3	SiHF530STRL-GE3 ^a	SiHF530STRR-GE3 ^a	
Lead (Pb)-free	IRF530SPbF	IRF530STRLPbF ^a	IRF530STRRPbFa	
	SiHF530S-E3	SiHF530STL-E3 ^a	SiHF530STR-E3 ^a	
SnPb	IRF530S	IRF530STRL ^a	IRF530STRR ^a	
	SiHF530S	SiHF530STL ^a	SiHF530STR ^a	

Note a. See device orientation.

ABSOLUTE MAXIMUM RATINGS $T_C = 25$ °C, unless otherwise noted						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	100	V	
Gate-Source Voltage			V _{GS}	± 20	7 v	
Continuous Drain Current	V _{GS} at 10 V	$T_{\rm C} = 25 ^{\circ}{\rm C}$ $T_{\rm C} = 100 ^{\circ}{\rm C}$		14		
		T _C = 100 °C	I _D	10	Α	
Pulsed Drain Current ^a			I _{DM}	56		
Linear Derating Factor				0.59	W/°C	
Linear Derating Factor (PCB Mount)e				0.025	VV/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	69	mJ	
Avalanche Current ^a			I _{AR}	14	Α	
Repetitive Avalanche Energy ^a			E _{AR}	8.8	mJ	
Maximum Power Dissipation	T _C =	25 °C	P _D	88	W	
Maximum Power Dissipation (PCB Mount)e	T _A =	25 °C 25 °C	FD	3.7		
Peak Diode Recovery dV/dt ^c		dV/dt	5.5	V/ns		
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 175	°C	
Soldering Recommendations (Peak Temperature)	for 10 s		-	300 ^d]	

- Notes a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b. $V_{DD} = 25$ V, starting $T_J = 25$ °C, L = 528 μ H, $R_g = 25$ Ω , $I_{AS} = 14$ A (see fig. 12). c. $I_{SD} \le 14$ A, $dI/dt \le 140$ A/ μ s, $V_{DD} \le V_{DS}$, $T_J \le 175$ °C. d. 1.6 mm from case.

- When mounted on 1" square PCB (FR-4 or G-10 material).

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply

IRF530S, SiHF530S

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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	62		
Maximum Junction-to-Ambient (PCB Mount) ^a	R _{thJA}	-	40	°C/W	
Maximum Junction-to-Case (Drain)	R_{thJC}	-	1.7		

Note

a. When mounted on 1" square PCB (FR-4 or G-10 material).

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	100	-	-	V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference to 25 °C, I _D = 1 mA		-	0.12	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$		-	4.0	V
Gate-Source Leakage	I _{GSS}	,	V _{GS} = ± 20 V		-	± 100	nA
Zoro Coto Voltago Droin Current		V _{DS} =	V _{DS} = 100 V, V _{GS} = 0 V		-	25	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 80 V	V _{GS} = 0 V, T _J = 150 °C	-	-	250	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	$I_D = 8.4 A^b$	-	-	0.16	Ω
Forward Transconductance	g _{fs}	V _{DS} = 50 V, I _D = 8.4 A ^b		5.1	-	-	S
Dynamic							
Input Capacitance	C _{iss}	$V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$ f = 1.0 MHz, see fig. 5		-	670	-	
Output Capacitance	C _{oss}			-	250	-	pF
Reverse Transfer Capacitance	C _{rss}			-	60	-	
Total Gate Charge	Qg			-	-	26	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	$V_{GS} = 10 \text{ V}$ $I_D = 14 \text{ A}, V_{DS} = 80 \text{ V},$ see fig. 6 and 13 ^b		-	5.5	nC
Gate-Drain Charge	Q_{gd}		see lig. 6 and 16	-	-	11	1
Turn-On Delay Time	t _{d(on)}			-	10	-	
Rise Time	t _r	$V_{DD} = 50 \text{ V, } I_D = 14 \text{ A,}$ $R_g = 12 \ \Omega, \ R_D = 3.6 \ \Omega, \ \text{see fig. } 10^b$		-	34	-	ns ns
Turn-Off Delay Time	t _{d(off)}			-	23	-	
Fall Time	t _f			-	24	-	
Internal Drain Inductance	L_D	Between lead, 6 mm (0.25") from package and center of die contact		_	4.5	-	nH
Internal Source Inductance	L _S			_	7.5	-	
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	14	Α
Pulsed Diode Forward Current ^a	I _{SM}			-	-	56	73
Body Diode Voltage	V_{SD}	$T_{J} = 25 ^{\circ}\text{C}, I_{S} = 14 \text{A}, V_{GS} = 0 \text{V}^{\text{b}}$		-	-	2.5	V
Body Diode Reverse Recovery Time	t _{rr}	T _J = 25 °C, I _F = 14 A, dl/dt = 100 A/μs ^b		-	150	280	ns
Body Diode Reverse Recovery Charge	Q _{rr}			-	0.85	1.7	μC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn		on is dor	ninated b	y L _S and	L _D)

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width $\leq 300~\mu s;$ duty cycle $\leq 2~\%.$



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

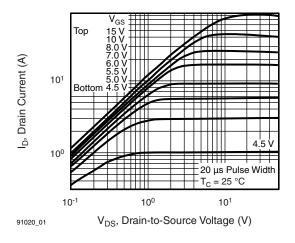


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

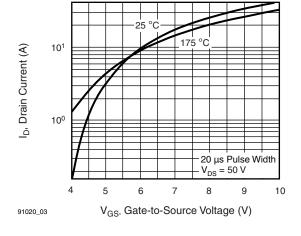


Fig. 3 - Typical Transfer Characteristics

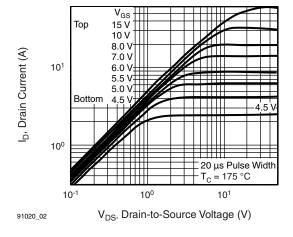


Fig. 2 - Typical Output Characteristics, T_C = 175 $^{\circ}$ C

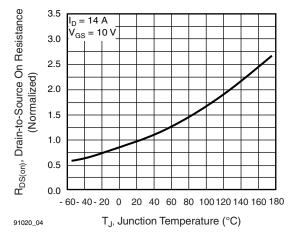
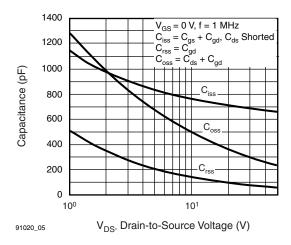


Fig. 4 - Normalized On-Resistance vs. Temperature

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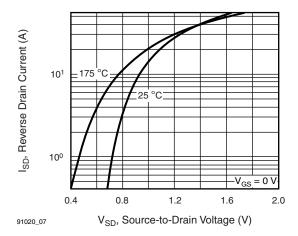
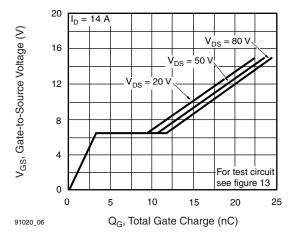


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

Fig. 7 - Typical Source-Drain Diode Forward Voltage



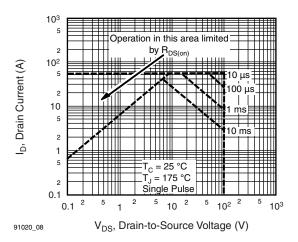


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

Fig. 8 - Maximum Safe Operating Area





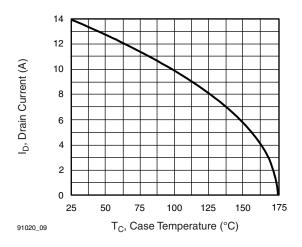


Fig. 9 - Maximum Drain Current vs. Case Temperature

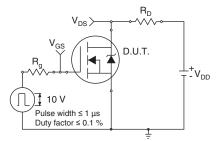


Fig. 10a - Switching Time Test Circuit



Fig. 10b - Switching Time Waveforms

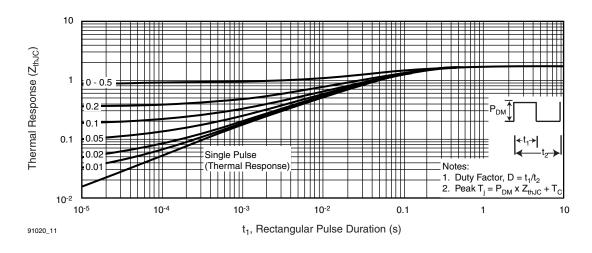
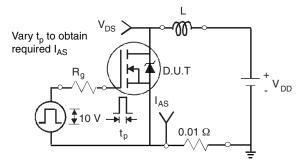


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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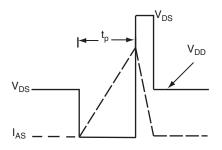


Fig. 12b - Unclamped Inductive Waveforms

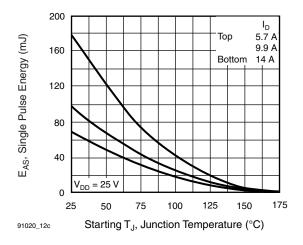


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

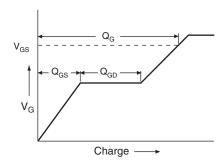


Fig. 13a - Basic Gate Charge Waveform

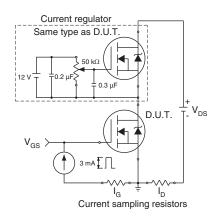
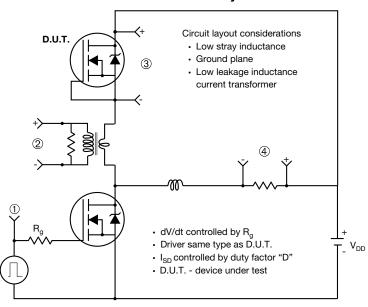


Fig. 13b - Gate Charge Test Circuit





Peak Diode Recovery dV/dt Test Circuit



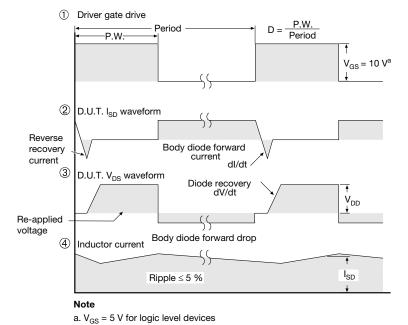


Fig. 14 - For N-Channel

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